

# **AF Control LSI** LC898229XI

#### Overview

This LSI is Closed-Auto Focus control LSI equipped with hall sensor. It consists of 1 system of feedback circuit and constant current driver. It has also a built-in EEPROM and temperature sensor.

#### **Features**

- Built-in Equalizer Circuit Using Digital Operation
  - ◆ AF Control Equalizer Circuit
  - Any Coefficient can be Specified by 2-wire Serial I/F (TWIF)
- 2-wire Serial Interface (The communication protocol is compatible with  $I^2C$ )
- Built-in A/D Converter
- Built-in D/A Converter
  - Hall Offset
  - Constant Current Bias
- Built-in Hall Sensor
  - ♦ Si Hall Sensor
- Built-in EEPROM
  - 64byte (16byte/page)
- Built-in OSC
- Built-in Constant Current Driver
  - ♦ 110 mA
- Package
- ...ss Max 0.29 mm, w. • WL-CSP 6-pin (2 x 3pin), Thickness Max 0.29 mm, with **Backside Coat** 
  - ◆ Lead-free, Halogen-free
- Supply voltage
  - V<sub>DD</sub> (2.6 V to 3.3



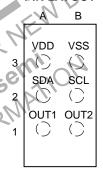
#### **DEVICE MARKING INFORMATION**

8229 YMZZ

8229= Specific Device Code

= Year M = Month = Assembly Lot

# PIN LAYOUT



(Top View)

Circuit Name	Number of PINs
Driver	2
Power	2
Logic	2

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
LC898229XI	WLCSP6	4000 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### **Pin Description**

Туре				
ı	Input			
0	Output			
В	Bidirection			
Р	Power supply, GND			
NC	Not Connected			

2-wire Serial Interface							
SCL I 2–wire serial interface clock pin							
SDA	В	2-wire serial interface data pin					

	L
	Driver Interface
OUT1	T1 O Driver output (to Actuator)
OUT2	T2 O Driver output (to Actuator)
	Davisa Cumple Bin
	Power Supply Pin
V <sub>DD</sub>	P Power supply
V <sub>SS</sub>	S P GND
TH	Power Supply Pin  DD P Power supply  SS P GND

Power Supply Pin					
$V_{DD}$	Р	Power supply			
V <sub>SS</sub>	Р	GND			

#### \*Process when Pins are Not Used

PIN TYPE "O" – Ensure that it is set to OPEN.

PIN TYPE "I" - OPEN is inhibited. Ensure that it is connected to the VDD or VSS even when it is unused.

(Please contact onsemi for more information about selection of VDD or VSS.)

PIN TYPE "B" - If you are unsure about processing method on the pin description of pin layout table, please contact us.

Note that incorrect processing of unused pins may result in defects.

**Table 1. ABSOLUTE MAXIMUM RATING (VSS = 0 V)** 

Item	Symbol	Condition	Rating	Unit
Supply voltage	V <sub>DD</sub> 33 max	Ta ≤ 25°C	-0.3~4.6	V
Input/output voltage	V <sub>I</sub> 33, V <sub>O</sub> 33	Ta ≤ 25°C	-0.3∼V <sub>DD</sub> 33+0.3	V
Storage ambient temperature	Tstg		<b>-55∼125</b>	°C
Operating ambient temperature	Topr		<b>−30~70</b>	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 2. ACCEPTABLE OPERATION RANGE at Ta =  $-30 \sim 70^{\circ}$ C, VSS = 0 V

Item	Symbol	Min	Тур	Max	Unit
Supply voltage	V <sub>DD</sub> 33	2.6	2.8	3.3	V
Input voltage range	V <sub>IN</sub>	0		$V_{DD}33$	V

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 3. DC CHARACTERISTICS: Input/output level at VSS = 0 V, VDD =  $2.6 \text{ V} \sim 3.3 \text{ V}$ , Ta =  $-30 \sim 70 ^{\circ}\text{C}$ 

Item	Symbol	Condition	Min	Тур	Max	Unit	Applicable Pins
High-level input voltage	$V_{IH}$	CMOS compliant Schmidt	1.4			11/2	SCL, SDA
Low-level input voltage	$V_{IL}$	Scrimiat			0.4	<b>\</b>	
Low-level output voltage	V <sub>OL</sub>	IOL = 2 mA		<b>~O</b>	0.2	V	SDA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Table 4. DRIVER OUTPUT (OUT1, OUT2) at VSS = 0 V, VDD = 2.8 V, Ta = 25°C

Item	Symbol	Condition	Min Typ	Max	Unit	Applicable Pins
Maximum current	I <sub>full</sub>		105 110	115	mA	OUT1, OUT2

Table 5. NON-VOLATILE MEMORY CHARACTERISTICS

Item	Symbol	Condition Min	Тур	Max	Unit	Applicable Circuit
Endurance	EN	CE DI		1000	Cycles	EEPROM
Data retention	RT	10			Years	
Write time	twn	1.5		20	ms	
THIS DEV	REP	RE				

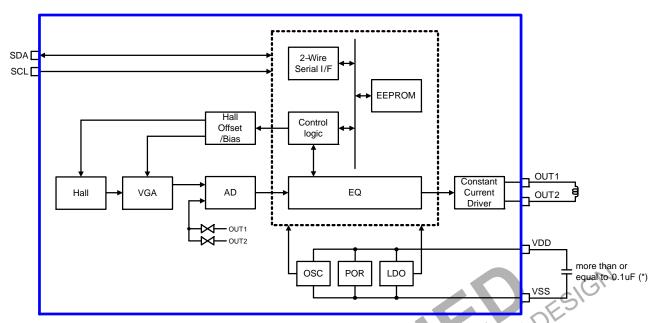


Figure 1. Block Diagram

NOTE: Consider capacitance of capacitor between V<sub>DD</sub> and V<sub>SS</sub>. According to power source environment, attach an additional capacitor in camera module.

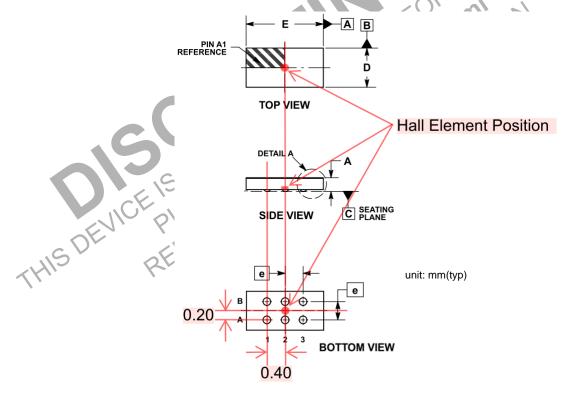


Figure 2. Hall Element Position

NOTE: Please refer to package diagram for each dimension.

#### **AC Characteristics**

#### **VDD Supply Timing**

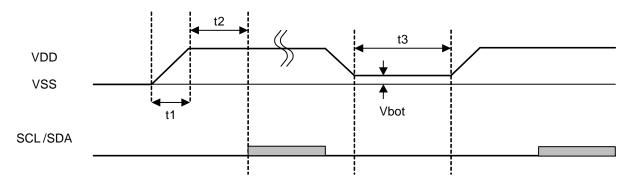


Figure 3. VDD Supply Timing

It is available to use 2-wire serial interface 5ms later for Power On Reset of VDD

Item	Symbol	Min Typ	Max	Unit
V <sub>DD</sub> turn on time	t1	VIE .	3	ms
2-wire serial interface start time from VDD on	t2	5		ms
V <sub>DD</sub> off time	t3	100	N	ms
Bottom Voltage	Vbot	10 00 11	0.1	V

# **AC Specification**

Figure 4 shows interface timing definition and Table 6 shows electric characteristics.

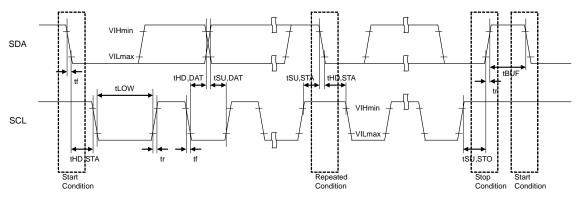


Figure 4. 2-wire Serial Interface Timing Definition

Table 6. ELECTRIC CHARACTERISTICS for 2-wire Serial Interface (AC Characteristics)

	1								
			Fast-mode		Fast-mode Plus				
Item	Symbol	Pin Name	Min	Тур	Max	Min	Тур	Max	Units
SCL clock frequency	FSCL	SCL			400	R'i		1000	KHz
START condition hold time	t <sub>HD</sub> , STA	SCL, SDA	0.6		760	0.26	017		μS
SCL clock Low period	t <sub>LOW</sub>	SCL	1.3	2E		0.5			μS
SCL clock High period	<sup>t</sup> HIGH	SCL	0.6	70.	R	0.26			μS
Setup time for repetition START condition	t <sub>SU</sub> , STA	SCL, SDA	0.6	10/	7/FC	0.26			μS
Data hold time	t <sub>HD</sub> , DAT	SCL, SDA	0 (Note 1)	2	0.9	0 (Note 1)			μS
Data setup time	t <sub>SU</sub> , DAT	SCL, SDA	100	O,		50			ns
SDA, SCL rising time	t <sub>r</sub>	SCL, SDA	TIE		300			120	ns
SDA, SCL falling time	The Management of the Manageme	SCL, SDA	71,		300			120	ns
STOP condition setup time	t <sub>SU</sub> , STO	SCL, SDA	0.6			0.26			μS
Bus free time between STOP and START	t <sub>BUF</sub>	SCL, SDA	1.3			0.5			μs

<sup>1.</sup> This LSI is designed for a condition with typ. 20 ns of hold time. If SDA signal is unstable around falling point of SCL signal, please implement an appropriate treatment on board, such as inserting a resistor.





#### WLCSP6 0.86x1.70x0.265 CASE 567UK **ISSUE A**

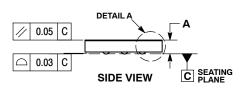
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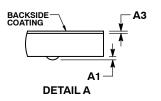
### NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS.
  3. DATUM C, THE SEATING PLANE, IS DEFINED BY
- THE SPHERICAL CROWNS OF CONTACT BALLS. COPLANARITY APPLIES TO SPHERICAL CROWNS
- OF CONTACT BALLS.
  DIMENSION b IS MEASURED AT THE MAXIMUM CONTACT BALL DIAMETER PARALLEL TO DATUM C.

	MILLIMETERS					
DIM	MIN	NOM	MAX			
Α	0.24	0.265	0.29			
A1	0.04 REF					
АЗ	0.025 REF					
b	0.12	0.17	0.22			
D	0.81	0.86	0.91			
E	1.65	1.70	1.75			
e		0.40 BSC	;			

# A B PIN A1 REFERENCE **TOP VIEW**





# **GENERIC MARKING DIAGRAM\***



= Assembly Location

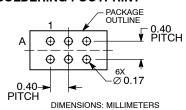
= Wafer Lot

Υ = Year

W = Work Week

е  $\oplus$ Ф  $\oplus$ 6x ∅ b 0.05 CAB 0.03 С **BOTTOM VIEW** 

#### RECOMMENDED **SOLDERING FOOTPRINT\***



\*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present. Some products may not follow the Generic Marking.

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